# SiHG61N65EF



**Vishay Siliconix** 

RoHS

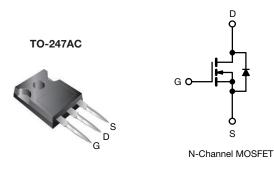
COMPLIANT

HALOGEN

FREE

# **E Series Power MOSFET with Fast Body Diode**

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700			
R <sub>DS(on)</sub> typ. at 25 °C (Ω)	$V_{GS} = 10 V$	0.041		
Q <sub>g</sub> max. (nC)	371			
Q <sub>gs</sub> (nC)	65			
Q <sub>gd</sub> (nC)	93			
Configuration	Single			



### FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t<sub>rr</sub>, Q<sub>rr</sub>, and I<sub>RRM</sub>
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Low switching losses due to reduced Q<sub>rr</sub>
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Telecommunications
  - Server and telecom power supplies
- Lighting
  - High-intensity lighting (HID)
  - Light emitting diodes (LEDs)
- Consumer and computing
- ATX power supplies
- Industrial
  Welding
  - Battery chargers
- Renewable energy
- Solar (PV inverters)
- Switching mode power supplies (SMPS)
- Applications using the following topologies
- LLC
- Phase shifted bridge (ZVS)
- 3-level inverter
- AC/DC bridge

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-Free and Halogen-Free	SiHG61N65EF-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)								
PARAMETER			SYMBOL	LIMIT	UNIT			
Drain-Source Voltage			V <sub>DS</sub>	650	V			
Gate-Source Voltage			V <sub>GS</sub>	± 30	V			
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I <sub>D</sub>	64				
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		41	А			
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	199				
Linear Derating Factor				4.2	W/°C			
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	1142	mJ			
Maximum Power Dissipation			P <sub>D</sub>	520	W			
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C			
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		-l\//-lt	70				
Reverse Diode dV/dt <sup>d</sup>			dV/dt	50	V/ns			
Soldering Recommendations (Peak Temperature) <sup>c</sup>	For	10 s		300	°C			

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 9 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D, \, dI/dt = 500$  A/µs, starting  $T_J = 25 \ ^\circ C.$ 

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 40 - 0.24			°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>							
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	nless otherwis	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static		<u>.</u>						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 µA	650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 10 mA	-	0.81	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 3	250 µA	2.0	-	4.0	V
Cata Sauraa Laakaga	V <sub>GS</sub> = ± 20 V		V	-	-	± 100	nA	
Gate-Source Leakage	I <sub>GSS</sub>	,	$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
Zero Gate Voltage Drain Current	1	V <sub>DS</sub> =	$V_{DS} = 520 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	
	IDSS	V <sub>DS</sub> = 520 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			-	-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub>	= 30.5 A	-	0.041	0.047	Ω
Forward Transconductance	<b>g</b> fs	$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 30.5 \text{ A}$			-	23	-	S
Dynamic		<u>.</u>						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,			-	7407	-	-
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 100 V,$		-	351	-		
Reverse Transfer Capacitance	C <sub>rss</sub>		f = 1 MHz		-	3	-	1
Effective Output Capacitance, Energy Related <sup>a</sup>	$C_{o(er)}$	$V_{DS}$ = 0 V to 520 V, $V_{GS}$ = 0 V		-	233	-	pF	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	939	-		
Total Gate Charge	Qg	V <sub>GS</sub> = 10 V I <sub>D</sub> = 30.5		0.5 A, V <sub>DS</sub> = 520 V	-	247	371	nC
Gate-Source Charge	Q <sub>gs</sub>				-	65	-	
Gate-Drain Charge	Q <sub>gd</sub>				-	93	-	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 520 \text{ V}, \text{ I}_{D} = 30.5 \text{ A}, \\ \text{V}_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	59	89	ns	
Rise Time	t <sub>r</sub>			-	107	161		
Turn-Off Delay Time	t <sub>d(off)</sub>			-	217	326		
Fall Time	t <sub>f</sub>			-	133	200		
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain			0.5	1	2	Ω
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	IS	MOSFET symbol showing the integral reverse p - n junction diode		-	-	64	А	
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	199		
Diode Forward Voltage	V <sub>SD</sub>	$T_J = 25 \text{ °C}, I_S = 30.5 \text{ A}, V_{GS} = 0 \text{ V}$			-	0.9	1.2	V
				1	1	1		

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

t<sub>rr</sub>

Q<sub>rr</sub>

I<sub>RRM</sub>

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

**Reverse Recovery Time** 

Reverse Recovery Charge

**Reverse Recovery Current** 

 $T_J$  = 25 °C,  $I_F$  =  $I_S$  = 30.5 A, dI/dt = 100 A/ $\mu s,$   $V_R$  = 400 V

212

2.1

18

-

\_

\_

474

3.8

-

ns

μC

А



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

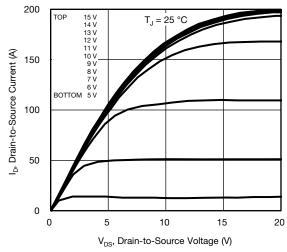
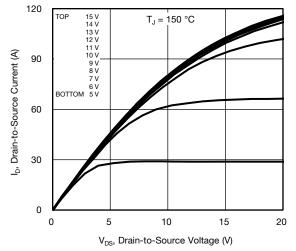
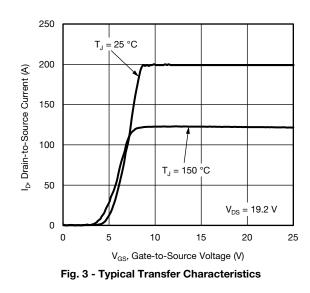


Fig. 1 - Typical Output Characteristics







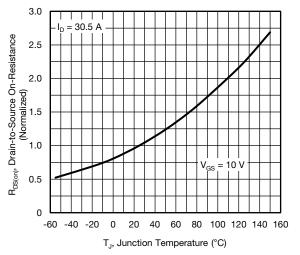


Fig. 4 - Normalized On-Resistance vs. Temperature

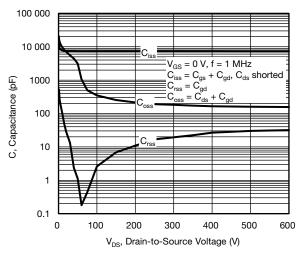
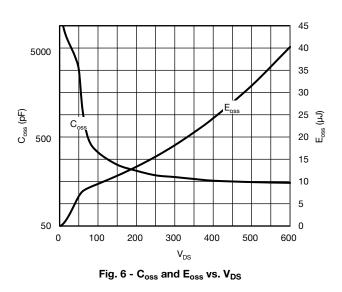


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91789

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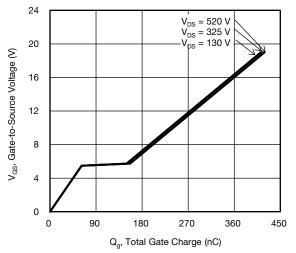


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

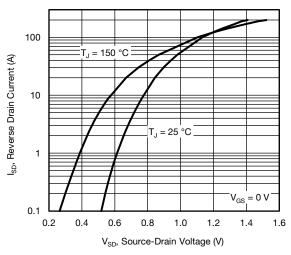
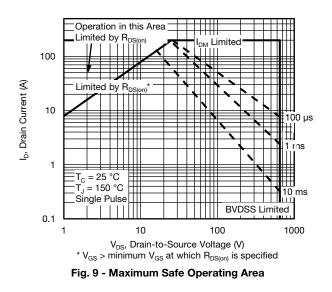


Fig. 8 - Typical Source-Drain Diode Forward Voltage



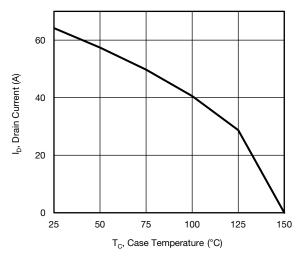


Fig. 10 - Maximum Drain Current vs. Case Temperature

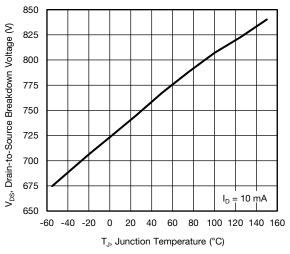


Fig. 11 - Temperature vs. Drain-to-Source Voltage

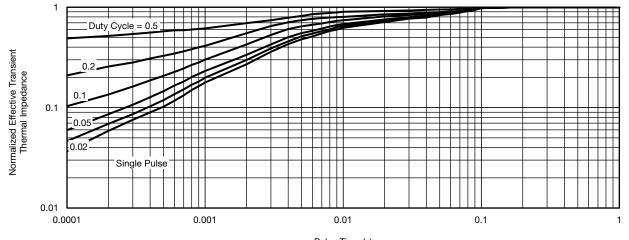
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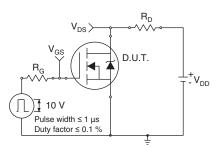


Fig. 13 - Switching Time Test Circuit

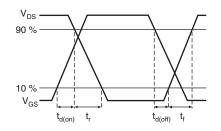


Fig. 14 - Switching Time Waveforms

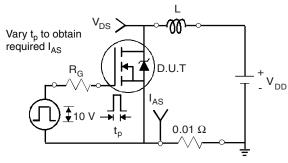


Fig. 15 - Unclamped Inductive Test Circuit

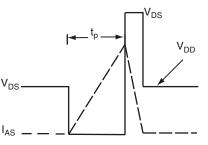


Fig. 16 - Unclamped Inductive Waveforms

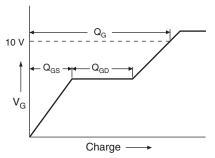


Fig. 17 - Basic Gate Charge Waveform

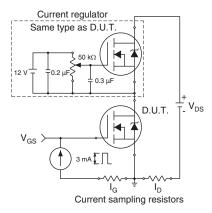


Fig. 18 - Gate Charge Test Circuit

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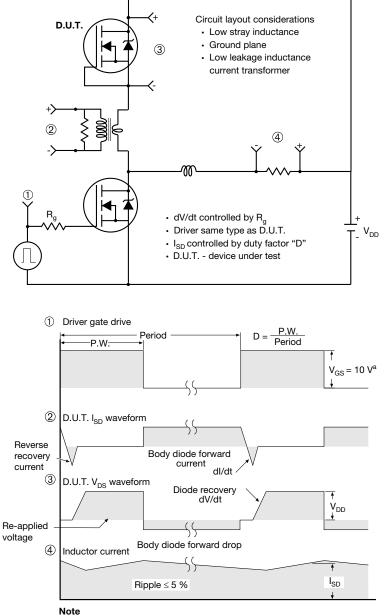
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 19 - For N-Channel

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